JABIL

100G QSFP28 DR1 Optical Transceive Compact in networking eqipment

- Compatibility with SMF connectors and cable *APPLICATIONS*
 100GbE connectivity for large-scale cloud and enterprise data centers
- Application supports openation with Forward Correction (FEC)
- CAUI-4 compliant electric interface per IEEE 8
- Power dissipation *⊲*.5W
- Operating temperature range: 0°to 70°C
- Full module diagnostics and control through I compliant with SFF-8636
- Single 3.3V power supply
- RoHS-6 compliance

ABSOLUTE MAXIMUM RATINGS

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

LOW-SPEED ELECTRICAL SPECIFICATIONS

Pcon	-	-	3.5	W
Vih	+2.8	-	+3.3	V
Vil	-0.3	-	+0.8	V
Voh	+2.8	-	+3.3	V
Vol	0.0	-	+0.4	V
	-	-	30	mA
	-	-	30	mA
	-	-	3	mA

(*) IntL

(**) Requires a host board pull-up to Vcc of 5k or less.

Optical Transmitter

The 100G DR1 optical transceiver electric interface is based on IEEE 802.3 CAUI-4 host to module retimed interface. Optical transmitter/receiver specifications are compliant with 100G DR specification.

TRANSMITTER ELECTRICAL INPUT CHARACTERISTICS

	-	25.8	-	Gbps	
Vin_CM	-400	-	2850	mV	
	-	-	10	%	
Vin_pp	300	-	900	mV	
Vin_se	-0.4	-	3.3	V	
CL	-	-	10	dB	Chip-to-chip @ 12.9 GHz
	-	-	1e-15		With stressed input signal per IEEE802.3bm Annex 83E.3.4.2
	Minimum per IEEE802.3bm Annex 83E.				
	Minimum per IEEE802.3bm Annex 83E.	-			

RECEIVER OPTICAL INPUT CHARACTERISTICS

		PAM4			
BR	106.24	106.25	106.26	Gbps	
BR	53.12	53.125	53.13	Gbd	
	1304.5 to 131 1311 center w	7.5 /avelength		nm	
		·			

	1		

Electrical PIN Assignment

The 100 Gbps DR1 QSFP28 optical transceiver pinout is compliant with the QSFP specifications in SFF-8436. The table below lists and describes all of the electrical pins of the module.

ELECTRICAL CONNECTOR PAD LAYOUT

TOP SIDE VIEWED FROM TOP BOTTOM SIDE VIEWED FROM BOTTOM

QSFP28 MODULE ELECTRICAL CONNECTOR PIN DEFINITIONS

1		GND	Ground	1	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3	
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	3	
4		GND	Ground	1	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	3	
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3	
7		GND	Ground	1	1
8	LVTTL-I	ModSelL	Module Select	3	
9	LVTTL-I	ResetL	Module Reset	3	
10		VccRx	+3.3V Power Supply, Receiver	2	2
11	LVCMOS-I/O	SCL	2 Wire Serial Interface Clock	3	
12	LVCMOS-I/O	SDA	2 Wire Serial Interface Data	3	
13		GND	Ground	1	1
14	CML-0	Rx3p	Receiver Non-Inverted Data Output	3	
15	CML-0	Rx3n	Receiver Inverted Data Output	3	
16		GND	Ground	1	1
17	CML-0	Rx1p	Receiver Non-Inverted Data Output	3	
18	CML-0	Rx1n	Receiver Inverted Data Output	3	
19		GND	Ground	1	1
20		GND	Ground	1	1
21	CML-0	Rx2n	Receiver Inverted Data Output	3	
22	CML-0	Rx2p	Receiver Non-Inverted Data Output	3	
23		GND	Ground	1	1
24	CML-0	Rx4n	Receiver Inverted Data Output	3	

Control and Monitoring Interface

The 100 Gbps DR1 QSFP28 Optical Transceiver hardware pins support a full SFF-8436 and SFF-8636–compliant set of control,

Management Interface

GENERAL FUNCTIONALITY

An I²C interface shall be used for management interface between the optical transceiver and the host system. The communication protocol shall follow the industry standard SFF-8636 specification for common management interface. Additional detail and clarified functionality are described in this sub-section.

MONITOR ACCURACY

The 100G DR1 module analog monitors have accuracy as defined below.

RX input power	+/- 3 dB
TX output power	+/- 3 dB
TX bias current	+/- 10%
Module temperature	+/- 3C
Module supply voltages	+/- 3%

REGISTER MAPPING

The module complies with the SFF-8636 memory map specification for a QSFP28 module.

0	2	ID and Status	3	Read-Only
3	21	Interrupt Flags (Clear on read)	19	Read-Only
22	33	Free Side Device Monitors	12	Read-Only
34	81	Channel Monitors	48	Read-Only
82	85	Reserved	4	Read-Only
86	99	Control	14	Read/Write
100	106	Free Side Interrupt Masks	7	Read/Write
107	110	Free Side Device Properties	4	Read-Only
111	112	Assigned to PCI Express	2	Read/Write

REGISTER MAPPING CONT.

Nid(F)0. 51(386 6e258 8 c	s 261635 Bc)-6(s	s) Aree Side Device Properties	4 1	
	1			
	1			
	1			1

Mechanical Specifications

QSFP28 DIMENSIONS

Label Specification

The following printed label is attached to the product (note that the certification labels will be added/removed according to requests and certification process results):

Regulatory and Compliance

• EN 55024 (EU) • IEC EN 61000-4-3 (International)	EMC Directive 89/336/EEC IEC /CISPR/24
 CISPR 22, class B (Comité International Spécial des Perturbations Radioélectriques — CISPR; Special international committee on radio interference. International). AS/NZS CISPR22 (Australia/New Zealand) 	 VCCI-03 (Japan) FCC 47 CFR Part 15, class B (US) ICES-003, Issue 4 (Canada) EN 55022 (EU) EMC Directive 2004/108/EEC (EU)
Per MIL-STD 883C Method 3015.4 or ANSI/ESI IEC EN 61000-4-2; +/- 8kV contact, +/- 15kV air	DA/JEDEC JS-001-2012 (component level).
 UL Recognized Component: UL 60950-1 (2nd E No. 60950-1 (2007) Information Technology Ed TUV Bauart Certificate: EN 60950-1 (2006+ A1 CB Certificate: IEC 60950-1 (2005 +A1:2009) In 	Ed.) Information Technology Equipment; CAN/CSA-C22.2 quipment; UL94-V0 flammability. 2:2012) Information Technology Equipment. nformation Technology Equipment.
 PCB material must be fully compliant to UL796; Ter Cables and connectors must have a flammability ratings of Label materials must have a flammability ratings of V 	mperature class B (IEC 60085); flammability class V-0- UL94). atings of VO-UL94; Service temp. 90 C. f VO-UL94; Service temp. 90 C. 'O-UL94; Service temp. 85 C.
 FDA/CDRH certified with accession number, Class 1 laser product: U.S. 21 CFR 1040; UL mark UL Certificate: IEC 60825-1:2014; EN 60825-1:2014 + A11:2021 	 Complies with 21 CFR 1040.10 and 1040.11 except for conformance with IEC 60825-1 Ed. 3., as described in Laser Notice No. 56, dated May 8, 2019. Caution – Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.
 2002/95/EC and the revised and recast Directive 2011/65/EC (RoHS) Restriction on Hazardous Substances. 2006/1907/EC (REACH) Registration, Evaluation, Authorization of Chemicals. 	 JIG 101-A, JIG 101-B Joint Industry Guide Japanese Material Composition Declaration. CAITEC SJ/T 11363-2006 Requirements for Concentration Limits for Certain Hazardous Substances in Electronic Information Products (China RoHS)

• Complies with RoHS II Directive 2011/65/EU.

Ordering Information

100 Gb/s DR1 QSFP28	055000	104.250	E00m	C Tomp
connector, 500m Reach	031120	100.230	30011	Chemp

Margin .5″

Document Version

1.0	11/24/2023	Initial specification version
1.1	7/8/2024	Updated Regulatory and Compliance

JABIL CIRCUIT SDN BHD

jabil.com

About Jabil

